

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE40P20Q uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$, This device is suitable for use as a load switch or power management.

Application

- Power management
- Load switch

100% UIS TESTED! 100% ΔVds TESTED!

General Features

• $V_{DS} = -40V, I_{D} = -20A$

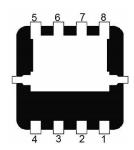
 $R_{DS(ON)}$ <18m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ <28m Ω @ V_{GS} =-4.5V

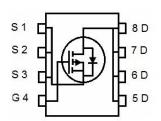
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

DFN 3.3X3.3





Top View Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE40P20Q	NCE40P20Q	DFN3.3X3.3-8L			

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	-20	Α
Drain Current-Pulsed (Note 1)	I _{DM}	-80	Α
Maximum Power Dissipation	P _D	30	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	Rejc	4.17	°C/W



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Electrical Characteristics (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	Breakdown Voltage BV _{DSS} V _{GS} =0V I _D =-250µA		-40	-	-	V
Zero Gate Voltage Drain Current	Gate Voltage Drain Current I _{DSS} V _{DS} =-40V,V _{GS} =0V		-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-1.2	-1.8	-2.4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-20A	-	14	18	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-20A	-	21.5	28	
Forward Transconductance	g FS	V _{DS} =-10V,I _D =-20A	-	25	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	Clss	\/ 00\/\/ 0\/	-	2800	-	PF
Output Capacitance	Coss	V_{DS} =-20V, V_{GS} =0V, F=1.0MHz	-	300	-	PF
Reverse Transfer Capacitance	Crss	F-1.UIVIDZ	-	275	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	11	-	nS
Turn-on Rise Time	t _r	V _{DD} =-20V, ID=-20A,	-	9.4	-	nS
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ V_{GS} =-10 V , R_{GEN} =3 Ω		24	-	nS
Turn-Off Fall Time	t _f		-	12	-	nS
Total Gate Charge	Qg		-	54	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-20V,I _D =-20A,V _{GS} =-10V	-	8	-	nC
Gate-Drain Charge	Q _{gd}	1		11	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-20A	-	-	-1.2	V

Notes

- $\textbf{1.} \ \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

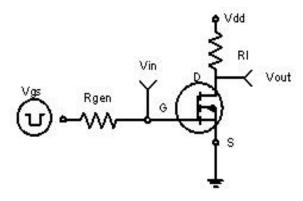


Figure 1 Switching Test Circuit

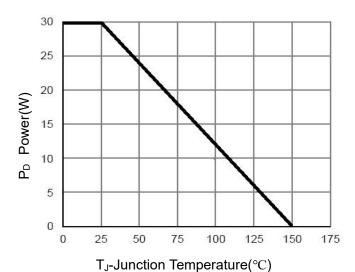


Figure 3 Power Dissipation

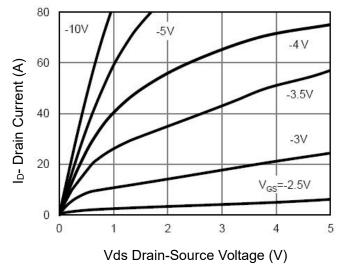


Figure 5 Output Characteristics

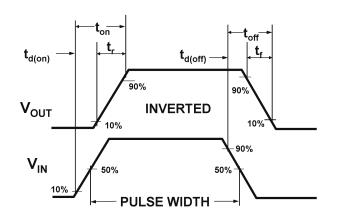


Figure 2 Switching Waveforms

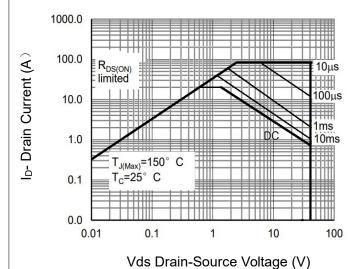


Figure 4 Safe Operation Area

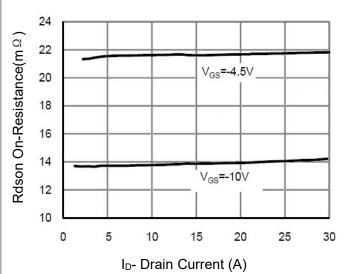
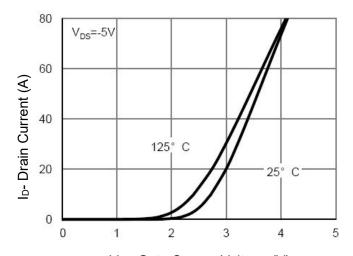


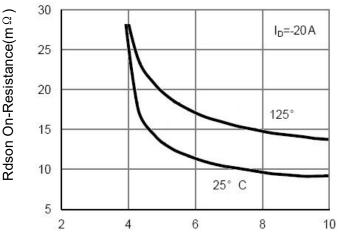
Figure 6 Drain-Source On-Resistance





Vgs Gate-Source Voltage (V)





Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

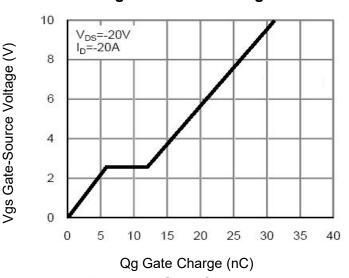
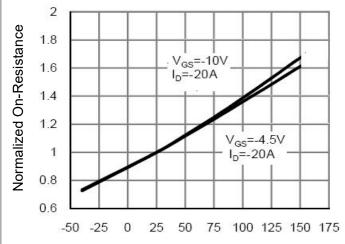
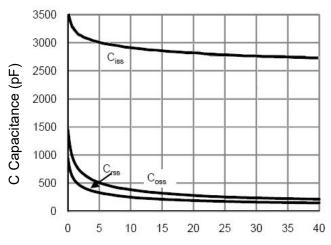


Figure 11 Gate Charge



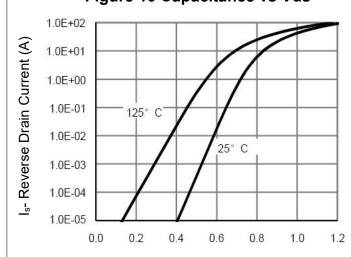
T_J-Junction Temperature(°C)





Vds Drain-Source Voltage (V)

Figure 10 Capacitance vs Vds



Vsd Source-Drain Voltage (V)

Figure 12 Source- Drain Diode Forward



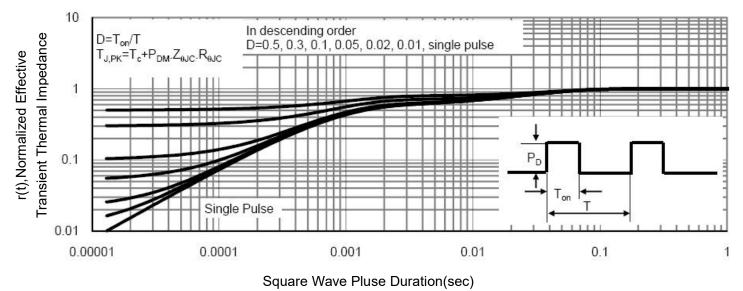
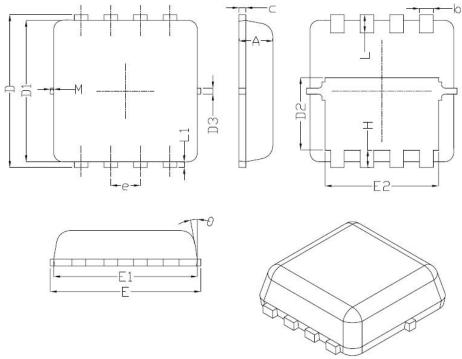


Figure 13 Normalized Maximum Transient Thermal Impedance

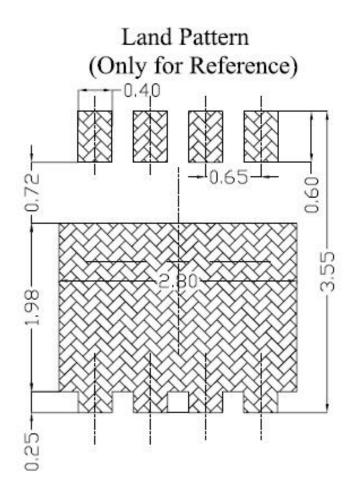


DFN3.3X3.3-8L Package Information



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Complete I	Dimensions In Millimeters					
Symbol	Min.	Nom.	Max.			
A	0.70	0.75	0.80			
b	0.25	0.30	0.35			
С	0.10	0.15	0.25			
D	3.25	3.35	3.45			
D1	3.00	3.10	3.20			
D2	1.48	1.58	1.68			
D3	-	0.13	-			
E	3.20	3.30	3.40			
E1	3.00	3.15	3.20			
E2	2.39	2.49	2.59			
е	0.65BSC					
Н	0.30	0.39	0.50			
L	0.30	0.40	0.50			
L1	-	0.13	-			
M	*	*	0.15			
θ		10°	12 [°]			







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